

# THE TOTEM ON-LINE RADIATION MONITORING SYSTEM



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### Introduction

The TOTEM experiment consists of three sub-detectors: the Roman Pot (RP) Silicon Detectors, located in the LHC tunnel near the Interaction Point 5 (IP5) and two inelastic telescopes, T1 and T2, located in the CMS end-cap regions.



## Hardware and System Layout

The basic unit of the RADMON system is the Integrated Sensor Carrier (ISC) that host radiation sensors connected to the readout electronics via long signal cables. The ISC PCB used in TOTEM is configured with 2 RadFET sensors for TID measurements, 2 p-i-n diodes to monitor the  $\Phi_{eq}$  and 1 Temperature probe (NTC).

The different sensor types provide the required sensitivity and dynamic range to the system for its

**Integrated Sensor Carrier** - 'bs' - 11 • RadFET REM 501K



**RADMON ISC installed** in a RP Motherboard

Detectors is

with one

Roman Pots at 147m, 220m from the IP

**Inelastics Telescopes** 

T2

#### **TOTEM detectors are located** in areas where high radiation

levels are expected

Detectors Locations	TID (kGy/year)	Φ <sub>eq</sub> (cm <sup>-2</sup> y <sup>-1</sup> )
RP 147m Si Detectors	10	$> 1 \times 10^{13}$
RP 147m Motherboard	5	$7.5 \times 10^{12}$
T1	15	$1.5 \times 10^{13}$
T2	10	$1.5 \times 10^{15}$

Roman Pots at 147m, 220m from the IP

TID and  $\Phi_{ea}$  needed to evaluate the radiationinduced changes in the performance of the detectors, to survey the radiation damage on the front-end electronics and to verify the Monte Carlo simulations. Moreover this system can help to detect anomalous increases of radiation levels that may arise from accidental radiation burst such as beam losses or unstable beams. This set of information can finally be used to **better plan the** TOTEM operation scenario.

T1 half-arm (CSC)

**RP** unit

## **Control Software and System Performance**

The layout of the ISC (unique RL for all sensors on-board) imposes a sequential readout of the **RADMON** sensors connected to the same ELMB. A control library has been developed in PVSS to drive the switches and loop over the sensors with different currents and powering times. In order to match with the readout requirements, the commands given to the hardware are sent over the CAN bus using SDO (Single Digital Objects) which allow sequential operations on demand. With the present version of the library the readout of one ELMB (e.g. 6 ISCs) is performed in about 1min.

operation over the experiment lifetime.

• common Return Line (RL) • readout over 6-wires

• RadFET LAAS 1600

diode BPW34

diode CMRP

• NTC 10kΩ



RADMON ISC located on the RP Motherboard Other 12 ISCs are distributed over the T1 and T2 telescopes. For T1, the 8 ISCs are hosted in dedicated PCBs mounted on the CSC planes; while T2 is equipped with 4 ISCs located on the frontend PCB that read the signals from the GEM chambers.

The TOTEM RADMON read-out is based on **Embedded Local Monitor Boards (ELMBs)** and **ELMB-DACs**. This approach, already adopted and tested by the ATLAS experiment, simplifies the integration of the sensors in the DCS and makes it compatible with the existent JCOP DCS structure agreed by all LHC experiments. As shown in the Hardware Overview Diagram, the ELMB, communicates over the CAN bus with a PC of the DCS running the SCADA software (PVSS II). Each ELMB hosts 64 12-bit ADC channels (0-4.5 V). To power the RADMON sensors during the readout sequence, the 16 channels, 12-bit DAC-module allows the ELMB to drive currents. In the RADMON configuration, two ELMB-DAC boards can be connected simultaneously and controlled by one ELMB.



Temperature Coefficient of CMRP diode on ISC Measurement of the **Temperature coefficients** of the sensors

During the commissioning of the TOTEM RP Silicon Detectors installed in the LHC in 2009, it was possible to carry out a set of measurements to the system performance. evaluate These measurements, proved the reliability of the voltage measurements over the 300m signal lines that carry the RADMON signals from the RP Silicon Detectors to the ELMB system. The stability in the voltage readout has been determined to be better than 2mV.









shorted to ground. For this reason a series of switches (JFET transistors) on the PP board are opened by applying a voltage from DAC before starting the readout procedure. In the "normal close" position the JFETs short the sensor terminals.

#### References

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TOTEM RADMON Web Page: <u>http://totem.web.cern.ch/Totem/work\_dir/radmon/RadMon.html</u>

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